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103473848

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Chun-Chi Ke (09/05/2006) and Chien-Ping Huang  
(09/05/2006)

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): in parentheses after inventor name

- ☒ Assignment ☐ Merger ☐ Change of Name  
☐ Security Agreement ☐ Joint Research Agreement  
☐ Government Interest Assignment  
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☐ Other

2. Name and address of receiving party(ies)

Siliconware Precision Industries Co.,  
Ltd.

Name:

Internal Address:

Street Address:

No. 123, Sec. 3, Da Fong Rd., Tantz

City: Taichung

State:

Country: Taiwan ROC

Zip:

Additional name(s) & address(es) attached? ☐ Yes ☒ No

4. Application or patent number(s):

A. Patent Application No.(s)

This application

☒ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached?

☐ Yes ☒ No

5. Name and address to whom correspondence  
concerning document should be mailed:

Name: Peter F. Corless  
EDWARDS ANGELL PALMER & DODGE  
LLP

Internal Address: Atty. Dkt.: 80808(71987)

Street Address: P.O. Box 55874

City: Boston

State: MA Zip: 02205

Phone Number: (617) 517-5557

Fax Number: (888) 325-9132

Email Address: PCorless@eapdlaw.com

6. Total number of applications and  
patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

- ☐ Authorized to be charged by credit card  
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☐ None required (government interest not affecting title)

8. Payment Information

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Authorized User Name Peter F. Corless

9. Signature:

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December 26, 2007

Date

Peter F. Corless - 33,860

Name of Person Signing

Total number of pages including cover  
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01 0010021 40.00 DA

# ASSIGNMENT OF U.S. PATENT APPLICATION

In consideration of the sum of One Dollar in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, the undersigned

Inventor(s) 1. Chun-Chi KE 2. Chien-Ping HUANG  
Full Name(s) \_\_\_\_\_

Hereby sell, assign and transfer to

Assignee SILICONWARE PRECISION INDUSTRIES CO., LTD.  
Name and Address No. 123, Sec. 3, Da Fong Road, Tantz,  
Taichung, Taiwan, R.O.C.

(hereinafter called the Assignee) the entire right, title, and interest in and to any and all improvements which are disclosed in the Application for United States Letters Patent entitled

Title of Invention: SEMICONDUCTOR DEVICE HAVING CONDUCTIVE  
BUMPS AND FABRICATION METHOD THEREOF

Which application was

Complete either a) executed by the undersigned on \_\_\_\_\_  
b) filed on the \_\_\_\_\_  
Serial No. \_\_\_\_\_

Including any and all United States Letters Patents which may be granted therefore and any and all extensions, divisions, reissues, substitutes, renewals or continuations thereof, and the right to all benefits under the International Convention for the Protection of Industrial Property.

It is hereby authorized and requested that the Commissioner of Patents issue any and all of said Letters Patent, when granted, to said assignee.

Further, it is agreed that, when requested, without charge to but at the expense of said Assignee, the undersigned will execute all divisional, continuing, substitute, renewal, and reissue patent applications; execute all rightful other papers; and generally do everything possible which said Assignee shall consider desirable for aiding in securing and maintaining proper patent protection.

Date Signed at TAIWAN, R.O.C.  
On September 5, 2006

Inventor(s) Chun-Chi KE Chien-Ping HUANG  
Full Signature(s) \_\_\_\_\_  
\_\_\_\_\_